



Material Content Data Sheet



Sales Product Name		ICE3PCS03G		Issued		3. July 2019		
MA#		MA005341692						
Package		PG-DSO-8-41		Weight*		81.28 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.250	4.00	4.00	39983	39983
leadframe	inorganic material	phosphorus	7723-14-0	0.008	0.01		104	
	non noble metal	zinc	7440-66-6	0.034	0.04		414	
	non noble metal	iron	7439-89-6	0.673	0.83		8282	
wire	non noble metal	copper	7440-50-8	27.330	33.63	34.51	336266	345066
	noble metal	gold	7440-57-5	0.188	0.23	0.23	2315	2315
	encapsulation	organic material	carbon black	1333-86-4	0.142	0.17		1746
encapsulation	plastics	epoxy resin	-	4.589	5.65		56465	
	inorganic material	silicondioxide	60676-86-0	42.580	52.39	58.21	523902	582113
leadfinish	non noble metal	tin	7440-31-5	0.814	1.00	1.00	10013	10013
plating	noble metal	silver	7440-22-4	0.090	0.11	0.11	1102	1102
glue	plastics	acrylic resin	-	0.315	0.39		3882	
	noble metal	silver	7440-22-4	1.262	1.55	1.94	15526	19408
*deviation	< 10%				Sum in total:		100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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